

PATENT ASSIGNMENT COVER SHEET

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Stylesheet Version v1.2

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HONG CHANG	06/27/2014
CAI GONG	06/27/2014
YUE FENG	06/27/2014
YIFENG DENG	06/27/2014
XINNING LIU	06/27/2014
FEI PAN	06/27/2014
YUAN CHEN	06/27/2014
LONGXING SHI	06/27/2014
NA BAI	06/27/2014
JIAFENG ZHU	06/27/2014
JUN YANG	06/27/2014
YINGCHENG XIA	06/27/2014
RECEIVING PARTY DATA	
Name:	SOUTHEAST UNIVERSITY
Street Address:	NO. 2 SIPAILOU
Internal Address:	XUANWU, NANJING
City:	JIANGSU
State/Country:	CHINA
Postal Code:	210096
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14369651
CORRESPONDENCE DATA	
Fax Number:	(520)882-7643
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	5208827623
Email:	jgood@hayes-soloway.com
Correspondent Name:	NORMAN P. SOLOWAY
Address Line 1:	4640 E. SKYLINE DRIVE

PATENT

Address Line 4: TUCSON, ARIZONA 85718	
ATTORNEY DOCKET NUMBER:	JINGWEI OP13US662
NAME OF SUBMITTER:	NORMAN P. SOLOWAY
SIGNATURE:	/norman p. soloway/
DATE SIGNED:	07/03/2014
Total Attachments: 12 source=Assignment#page1.tif source=Assignment#page2.tif source=Assignment#page3.tif source=Assignment#page4.tif source=Assignment#page5.tif source=Assignment#page6.tif source=Assignment#page7.tif source=Assignment#page8.tif source=Assignment#page9.tif source=Assignment#page10.tif source=Assignment#page11.tif source=Assignment#page12.tif	

ASSIGNMENT

I, Hong Chang of Jiangsu, China having invented certain inventions and improvements in **CIRCUIT FOR ENHANCING ROBUSTNESS OF SUB-THRESHOLD SRAM MEMORY CELL** and having executed an application for Letters Patent of the United States of America describing the same and based thereon on the 27 day of June, 2014 (U.S. Patent Application Serial No. 14/369,651, filed June 27, 2014), for good and valuable consideration, the receipt of which is hereby acknowledged from **SOUTHEAST UNIVERSITY**, a Chinese University having its principal place of business at No. 2 Sipailou, Xuanwu, Nanjing, Jiangsu 210096 China (hereinafter called the Assignee), do hereby sell, assign and transfer unto the Assignee, its successors, and assigns my entire right, title, and interest, in and to said invention in the United States of America, including all rights, title and interest in the above-mentioned application and any divisional, continuing or reissue application or applications and any patent which may be issued on the said invention in the United States of America;

And for the same consideration I do agree that I will upon request execute any instrument which the Assignee may desire to carry this Assignment into effect and perfect the title transferred hereby or prosecute the above-mentioned application;

And I do hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America to issue Letters Patent on the said application to the Assignee;

And I do hereby jointly and severally covenant for myself and for my legal representatives that I have granted no right or license to make, use, or sell said invention to anyone except the Assignee, that prior to the execution of this deed my right, title, and interest in and to said inventions or any of them or any part thereof has not been otherwise encumbered by me, and that I have not executed and will not execute any instrument in conflict herewith.

IN WITNESS WHEREOF, I/we hereunto set my hand and seal on the day and year hereinafter noted.

Inventor's signature

Full name (typed or printed)

Hong Chang

Date

June 27, 2014

Witness:

Chen Yu Zhao

Date:

June 27, 2014

Witness:

Li Li Chen

Date:

June 27, 2014

ASSIGNMENT

I, Cai Gong of Jiangsu, China having invented certain inventions and improvements in **CIRCUIT FOR ENHANCING ROBUSTNESS OF SUB-THRESHOLD SRAM MEMORY CELL** and having executed an application for Letters Patent of the United States of America describing the same and based thereon on the 27 day of June, 2014 (U.S. Patent Application Serial No. 14/369,651, filed June 27, 2014), for good and valuable consideration, the receipt of which is hereby acknowledged from **SOUTHEAST UNIVERSITY**, a Chinese University having its principal place of business at No. 2 Sipailou, Xuanwu, Nanjing, Jiangsu 210096 China (hereinafter called the Assignee), do hereby sell, assign and transfer unto the Assignee, its successors, and assigns my entire right, title, and interest, in and to said invention in the United States of America, including all rights, title and interest in the above-mentioned application and any divisional, continuing or reissue application or applications and any patent which may be issued on the said invention in the United States of America;

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IN WITNESS WHEREOF, I/we hereunto set my hand and seal on the day and year hereinafter noted.

Inventor's signature Cai Gong Date June 27, 2014
Full name (typed or printed) Cai Gong

Witness: Chen Yu Zhao
Date: June 27, 2014

Witness: Li Li Chen
Date: June 27, 2014

ASSIGNMENT

I, Yue Feng of Jiangsu, China having invented certain inventions and improvements in **CIRCUIT FOR ENHANCING ROBUSTNESS OF SUB-THRESHOLD SRAM MEMORY CELL** and having executed an application for Letters Patent of the United States of America describing the same and based thereon on the 27 day of June, 2014 (U.S. Patent Application Serial No. 14/369,651, filed June 27, 2014), for good and valuable consideration, the receipt of which is hereby acknowledged from **SOUTHEAST UNIVERSITY**, a Chinese University having its principal place of business at No. 2 Sipailou, Xuanwu, Nanjing, Jiangsu 210096 China (hereinafter called the Assignee), do hereby sell, assign and transfer unto the Assignee, its successors, and assigns my entire right, title, and interest, in and to said invention in the United States of America, including all rights, title and interest in the above-mentioned application and any divisional, continuing or reissue application or applications and any patent which may be issued on the said invention in the United States of America;

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IN WITNESS WHEREOF, I/we hereunto set my hand and seal on the day and year hereinafter noted.

Inventor's signature Yue Feng Date June 27, 2014
Full name (typed or printed) Yue Feng

Witness: Chen yu Zhao
Date: June 27, 2014

Witness: Li li Chen
Date: June 27, 2014

ASSIGNMENT

I, Yifeng Deng of Jiangsu, China having invented certain inventions and improvements in **CIRCUIT FOR ENHANCING ROBUSTNESS OF SUB-THRESHOLD SRAM MEMORY CELL** and having executed an application for Letters Patent of the United States of America describing the same and based thereon on the 27 day of June, 20 14 (U.S. Patent Application Serial No. 14/369,651, filed June 27, 2014), for good and valuable consideration, the receipt of which is hereby acknowledged from **SOUTHEAST UNIVERSITY**, a Chinese University having its principal place of business at No. 2 Sipailou, Xuanwu, Nanjing, Jiangsu 210096 China (hereinafter called the Assignee), do hereby sell, assign and transfer unto the Assignee, its successors, and assigns my entire right, title, and interest, in and to said invention in the United States of America, including all rights, title and interest in the above-mentioned application and any divisional, continuing or reissue application or applications and any patent which may be issued on the said invention in the United States of America;

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IN WITNESS WHEREOF, I/we hereunto set my hand and seal on the day and year hereinafter noted.

Inventor's signature Yifeng Deng Date June 27, 2014
Full name (typed or printed) Yifeng Deng

Witness: Chen Yu Zhao Witness: Li Li Chen
Date: June 27, 2014 Date: June 27, 2014

ASSIGNMENT

I, Xinning Liu of Jiangsu, China having invented certain inventions and improvements in **CIRCUIT FOR ENHANCING ROBUSTNESS OF SUB-THRESHOLD SRAM MEMORY CELL** and having executed an application for Letters Patent of the United States of America describing the same and based thereon on the 27 day of June, 2014 (U.S. Patent Application Serial No. 14/369,651, filed June 27, 2014), for good and valuable consideration, the receipt of which is hereby acknowledged from **SOUTHEAST UNIVERSITY**, a Chinese University having its principal place of business at No. 2 Sipailou, Xuanwu, Nanjing, Jiangsu 210096 China (hereinafter called the Assignee), do hereby sell, assign and transfer unto the Assignee, its successors, and assigns my entire right, title, and interest, in and to said invention in the United States of America, including all rights, title and interest in the above-mentioned application and any divisional, continuing or reissue application or applications and any patent which may be issued on the said invention in the United States of America;

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IN WITNESS WHEREOF, I/we hereunto set my hand and seal on the day and year hereinafter noted.

Inventor's signature Xinning Liu Date June 27, 2014
Full name (typed or printed) Xinning Liu

Witness: Chen Yu Zhao Witness: Li Li Chen
Date: June 27, 2014 Date: June 27, 2014

ASSIGNMENT

I, Fei Pan of Jiangsu, China having invented certain inventions and improvements in **CIRCUIT FOR ENHANCING ROBUSTNESS OF SUB-THRESHOLD SRAM MEMORY CELL** and having executed an application for Letters Patent of the United States of America describing the same and based thereon on the 27 day of June, 2014 (U.S. Patent Application Serial No. 14/369,651, filed June 27, 2014), for good and valuable consideration, the receipt of which is hereby acknowledged from **SOUTHEAST UNIVERSITY**, a Chinese University having its principal place of business at No. 2 Sipailou, Xuanwu, Nanjing, Jiangsu 210096 China (hereinafter called the Assignee), do hereby sell, assign and transfer unto the Assignee, its successors, and assigns my entire right, title, and interest, in and to said invention in the United States of America, including all rights, title and interest in the above-mentioned application and any divisional, continuing or reissue application or applications and any patent which may be issued on the said invention in the United States of America;

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IN WITNESS WHEREOF, I/we hereunto set my hand and seal on the day and year hereinafter noted.

Inventor's signature

Fei Pan

Date

June 27, 2014

Full name (typed or printed) Fei Pan

Witness:

Chen Yu Zhao

Date:

June 27, 2014

Witness:

Li Li Chen

Date:

June 27, 2014

ASSIGNMENT

I, Yuan Chen of Jiangsu, China having invented certain inventions and improvements in **CIRCUIT FOR ENHANCING ROBUSTNESS OF SUB-THRESHOLD SRAM MEMORY CELL** and having executed an application for Letters Patent of the United States of America describing the same and based thereon on the 27 day of June, 20 14 (U.S. Patent Application Serial No. 14/369,651, filed June 27, 2014), for good and valuable consideration, the receipt of which is hereby acknowledged from **SOUTHEAST UNIVERSITY**, a Chinese University having its principal place of business at No. 2 Sipailou, Xuanwu, Nanjing, Jiangsu 210096 China (hereinafter called the Assignee), do hereby sell, assign and transfer unto the Assignee, its successors, and assigns my entire right, title, and interest, in and to said invention in the United States of America, including all rights, title and interest in the above-mentioned application and any divisional, continuing or reissue application or applications and any patent which may be issued on the said invention in the United States of America;

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IN WITNESS WHEREOF, I/we hereunto set my hand and seal on the day and year hereinafter noted.

Inventor's signature Yuan Chen Date June 27, 2014
Full name (typed or printed) Yuan Chen

Witness: Chen Yu Zhao
Date: June 27, 2014

Witness: Li Li Chen
Date: June 27, 2014

ASSIGNMENT

I, Longxing Shi of Jiangsu, China having invented certain inventions and improvements in **CIRCUIT FOR ENHANCING ROBUSTNESS OF SUB-THRESHOLD SRAM MEMORY CELL** and having executed an application for Letters Patent of the United States of America describing the same and based thereon on the 27 day of June, 2014 (U.S. Patent Application Serial No. 14/369,651, filed June 27, 2014), for good and valuable consideration, the receipt of which is hereby acknowledged from **SOUTHEAST UNIVERSITY**, a Chinese University having its principal place of business at No. 2 Sipailou, Xuanwu, Nanjing, Jiangsu 210096 China (hereinafter called the Assignee), do hereby sell, assign and transfer unto the Assignee, its successors, and assigns my entire right, title, and interest, in and to said invention in the United States of America, including all rights, title and interest in the above-mentioned application and any divisional, continuing or reissue application or applications and any patent which may be issued on the said invention in the United States of America;

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IN WITNESS WHEREOF, I/we hereunto set my hand and seal on the day and year hereinafter noted.

Inventor's signature Long xing shi Date June 27, 2014
Full name (typed or printed) Longxing Shi

Witness: Chen yu Zhao Witness: Li li chen
Date: June 27, 2014 Date: June 27, 2014

ASSIGNMENT

I, Na Bai of Jiangsu, China having invented certain inventions and improvements in **CIRCUIT FOR ENHANCING ROBUSTNESS OF SUB-THRESHOLD SRAM MEMORY CELL** and having executed an application for Letters Patent of the United States of America describing the same and based thereon on the 27 day of June, 2014 (U.S. Patent Application Serial No. 14/369,651, filed June 27, 2014), for good and valuable consideration, the receipt of which is hereby acknowledged from **SOUTHEAST UNIVERSITY**, a Chinese University having its principal place of business at No. 2 Sipailou, Xuanwu, Nanjing, Jiangsu 210096 China (hereinafter called the Assignee), do hereby sell, assign and transfer unto the Assignee, its successors, and assigns my entire right, title, and interest, in and to said invention in the United States of America, including all rights, title and interest in the above-mentioned application and any divisional, continuing or reissue application or applications and any patent which may be issued on the said invention in the United States of America;

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IN WITNESS WHEREOF, I/we hereunto set my hand and seal on the day and year hereinafter noted.

Inventor's signature Na Bai Date June 27, 2014
Full name (typed or printed) Na Bai

Witness: Chen Yu Zhao
Date: June 27, 2014

Witness: Li Li Chen
Date: June 27, 2014

ASSIGNMENT

I, Jiafeng Zhu of Jiangsu, China having invented certain inventions and improvements in **CIRCUIT FOR ENHANCING ROBUSTNESS OF SUB-THRESHOLD SRAM MEMORY CELL** and having executed an application for Letters Patent of the United States of America describing the same and based thereon on the 27 day of June, 2014 (U.S. Patent Application Serial No. 14/369,651, filed June 27, 2014), for good and valuable consideration, the receipt of which is hereby acknowledged from **SOUTHEAST UNIVERSITY**, a Chinese University having its principal place of business at No. 2 Sipailou, Xuanwu, Nanjing, Jiangsu 210096 China (hereinafter called the Assignee), do hereby sell, assign and transfer unto the Assignee, its successors, and assigns my entire right, title, and interest, in and to said invention in the United States of America, including all rights, title and interest in the above-mentioned application and any divisional, continuing or reissue application or applications and any patent which may be issued on the said invention in the United States of America;

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IN WITNESS WHEREOF, I/we hereunto set my hand and seal on the day and year hereinafter noted.

Inventor's signature Jia feng Zhu Date June 27, 2014
Full name (typed or printed) Jiafeng Zhu

Witness: Chen Yu Zhao Witness: Li Li Chen
Date: June 27, 2014 Date: June 27, 2014

ASSIGNMENT

I, Jun Yang of Jiangsu, China having invented certain inventions and improvements in **CIRCUIT FOR ENHANCING ROBUSTNESS OF SUB-THRESHOLD SRAM MEMORY CELL** and having executed an application for Letters Patent of the United States of America describing the same and based thereon on the 27 day of June, 2014 (U.S. Patent Application Serial No. 14/369,651, filed June 27, 2014), for good and valuable consideration, the receipt of which is hereby acknowledged from **SOUTHEAST UNIVERSITY**, a Chinese University having its principal place of business at No. 2 Sipailou, Xuanwu, Nanjing, Jiangsu 210096 China (hereinafter called the Assignee), do hereby sell, assign and transfer unto the Assignee, its successors, and assigns my entire right, title, and interest, in and to said invention in the United States of America, including all rights, title and interest in the above-mentioned application and any divisional, continuing or reissue application or applications and any patent which may be issued on the said invention in the United States of America;

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IN WITNESS WHEREOF, I/we hereunto set my hand and seal on the day and year hereinafter noted.

Inventor's signature Jun Yang Date June 27, 2014
Full name (typed or printed) Jun Yang

Witness: Chen Yu Zhao Witness: Li Li Chen
Date: June 27, 2014 Date: June 27, 2014

ASSIGNMENT

I, Yingcheng Xia of Jiangsu, China having invented certain inventions and improvements in **CIRCUIT FOR ENHANCING ROBUSTNESS OF SUB-THRESHOLD SRAM MEMORY CELL** and having executed an application for Letters Patent of the United States of America describing the same and based thereon on the 27 day of June, 2014 (U.S. Patent Application Serial No. 14/369,651, filed June 27, 2014), for good and valuable consideration, the receipt of which is hereby acknowledged from **SOUTHEAST UNIVERSITY**, a Chinese University having its principal place of business at No. 2 Sipailou, Xuanwu, Nanjing, Jiangsu 210096 China (hereinafter called the Assignee), do hereby sell, assign and transfer unto the Assignee, its successors, and assigns my entire right, title, and interest, in and to said invention in the United States of America, including all rights, title and interest in the above-mentioned application and any divisional, continuing or reissue application or applications and any patent which may be issued on the said invention in the United States of America;

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IN WITNESS WHEREOF, I/we hereunto set my hand and seal on the day and year hereinafter noted.

Inventor's signature Ying Cheng Xia Date June 27, 2014
Full name (typed or printed) Yingcheng Xia

Witness: Chen Yu Zhao
Date: June 27, 2014

Witness: Li Li Chen
Date: June 27, 2014